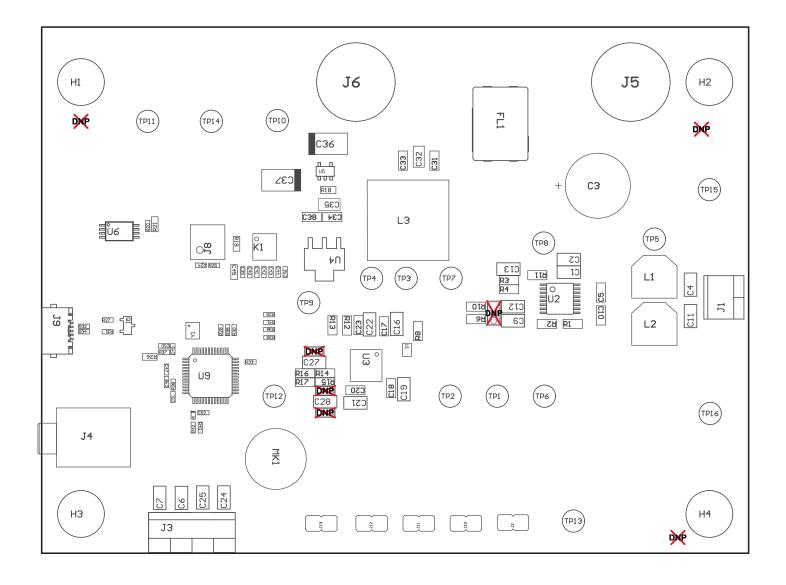
- ZZ1 These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ2 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ3 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00724 REV: A	SVN REV: Not In VersionControl
	TID #: TIDA-00724	
PLOT NAME = Top Assembly Drawing	GENERATED : 11/23/2015 2:24:38 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00724 REV: A	SVN REV: Not In VersionControl
	TID #: TIDA-00724	
PLOT NAME = Bottom Assembly Drawing	GENERATED : 11/23/2015 2:24:45	PM TEXAS INSTRUMENTS

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